



## NPN PLASTIC POWER TRANSISTORS

2N5294 2N5296 2N5298

TO-220 Leaded Plastic Package RoHS compliant

TO-220

## **FEATURE:**

1. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

## **APPLICATIONS:**

1. Medium Power Switching and Amplifier Applications

## ABSOLUTE MAXIMUM RATINGS (Ta = 25 Unless otherwise specified)

PARA	AMETER	SYMBOL	Max/Min	2N5294	2N5296	2N5298	UNIT
Collector-base voltage (open emitter)		$V_{CBO}$	Max	80	60	80	V
Collector-emitter	voltage (open base)	$V_{CEO}$	Max	70	40	60	V
Collector-emitter	voltage (V <sub>BE</sub> = 1.5V)	$V_{CEV}$	Max	80	60	80	V
Collector-emitter v	voltage ( $R_{BE}$ = 100Ω)	$V_{\sf CER}$	Max	75	50	70	V
Emitter-base volta	age (open base)	$V_{EBO}$	Max	7.0	5.0	5.0	V
Collector current		I <sub>C</sub>	Max		4.0		
Base current		l <sub>B</sub>	Max		2.0		
Collector emitter	$I_C = 0.5A$ ; $I_B = 0.05A$		Max	1.0			V
saturation		$V_{CEsat}$	Max		1.0		V
voltage	$I_C = 1.5A; I_B = 0.15A$	7	Max			1.0	V
	I <sub>C</sub> = 0.5A; V <sub>CE</sub> = 4V	h <sub>FE</sub>	Min	30			
			Max	120			
D.C. summant main	I <sub>C</sub> = 1A; V <sub>CE</sub> = 4V	h <sub>FE</sub> 1	Min		30		
D.C. current gain			Max		120		
	1 - 4 5 4 . \	h <sub>FE</sub> <sup>1</sup>	Min			20	
	$I_{C} = 1.5A; V_{CE} = 4V$		Max			80	
Total power dissipation up to $T_c = 25^{\circ}C$			Max		3	6	W
Derate above 25°C		$P_tot$	Max	0.288		W/°C	
Total power dissipation up to $T_A = 25^{\circ}C$		D	Max	1.8		W	
Derate above 25°C		$P_{tot}$	Max		0.0	144	W/°C
Junction temperature		T <sub>j</sub>	Max	150		°C	
Storage temperature		$T_{stg}$			-65 to	+150	°C

## THERMAL RESISTANCE

From junction to ambient	$R_{thj-a}$	70	°C/W
From junction to case	R <sub>th j-c</sub>	3.5	°C/W







ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	Max/ Min		2N5296	2N5298	UNIT
		V <sub>CE</sub> = 65V; V <sub>BE</sub> = 1.5V	Max	0.5		0.5	mA
		$V_{CE} = 35V; V_{BE} = 1.5V$	Max		2.0		mA
	I <sub>CEV</sub>	$V_{CE} = 65V; V_{BE} = 1.5V, T_{C} = 150$ °C	Max	3.0		3.0	mA
Collector cutoff current		$V_{CE} = 35V; V_{BE} = 1.5V, T_{C} = 150^{\circ}C$	Max		5.0		mA
		$V_{CE} = 50V; R_{BE} = 100\Omega$	Max	0.5		0.5	mA
	I <sub>CER</sub>	$V_{CE} = 50V; R_{BE} = 100\Omega, T_{C} = 150$ °C	Max	2.0		2.0	mA
Emitter cut-off current		$I_{\rm C}$ = 0; $V_{\rm EB}$ = 7V	Max	1.0			mA
Emiller cut-on current	I <sub>EBO</sub>	$I_{\rm C} = 0; V_{\rm EB} = 5V$	Max		1.0	1.0	mA
	$V_{CEO(sus)}^{1}$	$I_{\rm C} = 100 {\rm mA}; I_{\rm B} = 0$	Max	70	40	60	V
Breakdown voltages	V <sub>CBO</sub>	$I_{\rm C} = 1 \text{ mA}; I_{\rm E} = 0$	Max	80	60	80	V
	$V_{EBO}$	$I_{E} = 1 \text{ mA}; I_{C} = 0$	Max	7	5	5	V
	V <sub>CEsat</sub> 1	$I_{\rm C} = 0.5 \text{A}; I_{\rm B} = 0.05 \text{A}$	Max	1.0			V
Saturation voltages		$I_{\rm C} = 1A; I_{\rm B} = 0.1A$	Max		1.0		V
•		$I_{\rm C}$ = 1.5A; $I_{\rm B}$ = 0.15A	Max			1.0	V
	V <sub>BE(on)</sub> <sup>1</sup>	$I_{\rm C} = 0.5 A; V_{\rm CE} = 4 V$	Max	1.1			V
Base-emitter on voltage		$I_{\rm C} = 1A; V_{\rm CE} = 4V$	Max		1.3		V
		$I_C = 1.5A; V_{CE} = 4V$	Max			1.5	V
	h <sub>FE</sub> 1	$I_{\rm C}$ = 0.5A; $V_{\rm CE}$ = 4V	Min	30			
		I <sub>C</sub> = 0.5A, V <sub>CE</sub> = 4V	Max	120			
D.C. current gain		$I_{\rm C} = 1A; V_{\rm CE} = 4V$	Min		30		
3		.C, .CE	Max		120		
		$I_{\rm C}$ = 1.5A; $V_{\rm CE}$ = 4V	Min Max			20 80	
Transition frequency	f <sub>⊤</sub>	$I_{\rm C}$ = 0.2A; $V_{\rm CF}$ = 4V	Min	0.8	0.8	0.8	
Switching time	1 '1	.C G CE		1 0.0	0.0	0.0	
Owitoning time		V <sub>CC</sub> =30V; I <sub>C</sub> =0.5A; I <sub>B1</sub> =0.05A	Max	5			μs
Turn on time	t <sub>on</sub>	$V_{CC}=30V; I_{C}=1A; I_{B1}=0.1A$	Max		5		μs
Tam on amo		$V_{CC}=30V; I_{C}=1.5A; I_{B1}=0.15A$	Max			5	μs
	t <sub>off</sub>	$V_{CC}=30V$ ; $I_{C}=1.5A$ ; $I_{B1}=0.15A$	Max	15			μs
Turn off time		$V_{CC}=30V; I_{C}=1A; I_{B2}=0.1A$	Max		15		μs
Tani on anio		$V_{CC}=30V; I_{C}=1.5A; I_{B2}=0.15A$	Max			15	μs

## Notes:

1. Pulsed pulse duration =  $300\mu s$ ; duty factor = 0.018





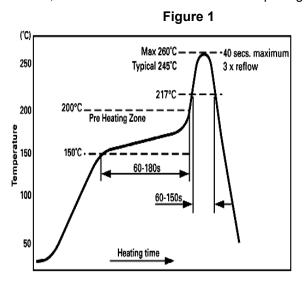


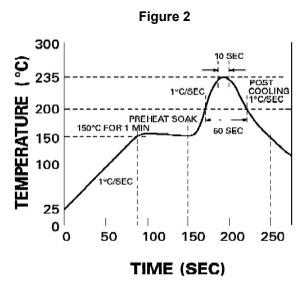
## **Recommended Reflow Solder Profiles**

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.





## Reflow profiles in tabular form

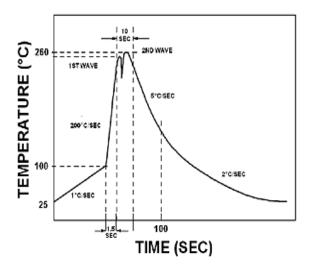
Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~3°C/second	~3°C/second
Preheat  - Temperature Range  - Time	150-170°C 60-180 seconds	150-200°C 60-180 seconds
Time maintained above:  – Temperature  – Time	200°C 30-50 seconds	217°C 60-150 seconds
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	40 seconds
Ramp-Down Rate	3°C/second max.	6°C/second max.



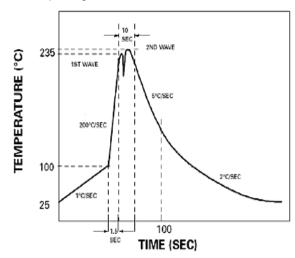


## **Recommended Wave Solder Profiles**

The Recommended solder Profile For Devices with Pb-free terminal plating where a Pb-free solder is used



The Recommended solder Profile For Devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with leaded solder



## **Wave Profiles in Tabular Form**

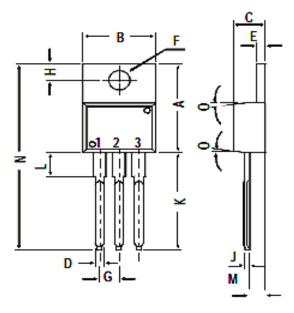
Profile Feature	Sn-Pb System	Pb-Free System	
Average Ramp-Up Rate	~200°C/second	~200°C/second	
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec	
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp	
Peak Temperature	235°C	260°C max.	
Time within +0 -5°C of actual Peak	10 seconds	10 seconds	
Ramp-Down Rate	5°C/second max.	5°C/second max	





## **PACKAGE DETAILS**

TO-220 Plastic Package

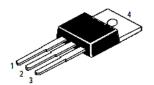


DIM	MIN.	MAX.
Α	14.42	16.51
В	9.63	10.67
С	3.56	4.83
D		0.90
Е	1.15	1.40
F	3.75	3.88
G	2.29	2.79
Н	2.54	3.43
J		0.56
K	12.70	14.73
L	2.80	4.07
М	2.03	2.92
N		31.24
0	7	,0

All Dimensions are in mm

## **PIN CONFIGURATION**

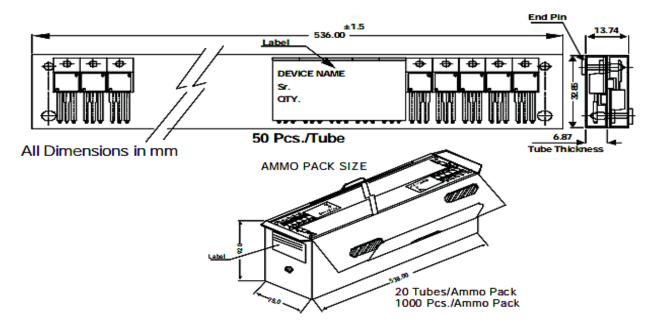
- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector







# **TO-220 Tube Packing**



# **Packing Details**

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	GrWt
TO-220 / FP	200 pcs/polybag	396 gm/200 pcs	3" x 7.5" x 7.5"	1.0K	17" x 15" x 13.5"	16.0K	36 kgs
	50 pcs/tube	120 gm/50 pcs	3.5" x 3.7" x 21.5"	1.0K	19" x 19" x 19"	10.0K	29 kgs





# Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- $\cdot\,$  The product shall be stored on a plane area. They should not be turned upside down.

They should not be placed against the wall.

#### **Shelf Life of CDIL Products**

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

## Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level					
Level	Time	Condition			
1	Unlimited	≤30 °C / 85% RH			
2	1 Year	≤30 °C / 60% RH			
2a	4 Weeks	≤30 °C / 60% RH			
3	168 Hours	≤30 °C / 60% RH			
4	72 Hours	≤30 °C / 60% RH			
5	48 Hours	≤30 °C / 60% RH			
5a	24 Hours	≤30 °C / 60% RH			
6	Time on Label(TOL)	≤30 °C / 60% RH			







#### **Customer Notes**

#### **Component Disposal Instructions**

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

## **Disclaimer**

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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